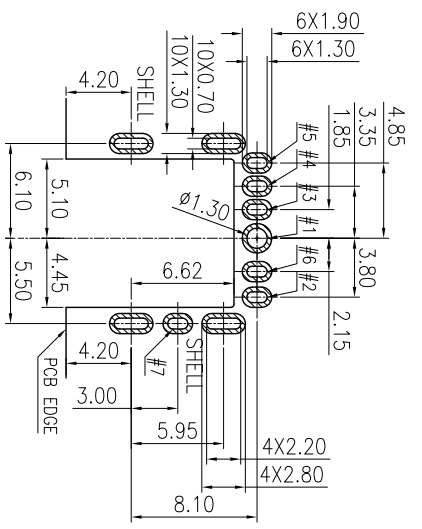
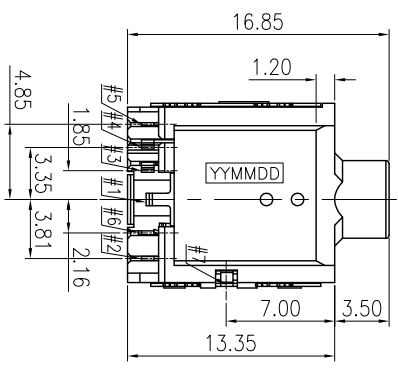
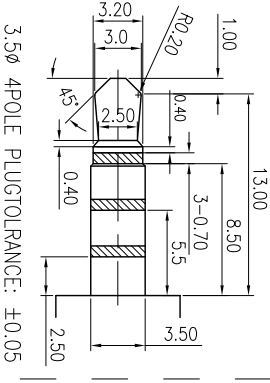
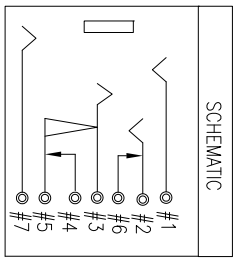


**SPECIFICATIONS:**

1. ELECTRICAL CHARACTERISTICS:
  - 1-1. RATING: 12V AC, 1A DC.
  - 1-2. CONTACT RESISTANCE: 50m Ω MAX.
  - 1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
  - 1-4. INSULATION RESISTANCE: 100MΩ MIN. MEASURED BY 500 VDC.
2. MECHANICAL CHARACTERISTICS:
  - 2-1. INSERTION FORCE : 0.3~3.0 KGf
  - 2-2. WITHDRAWAL FORCE : 0.3~2.0 KGf
3. LIFE TEST: 5,000 CYCLES MIN.
4. OTHER GENERAL SPEC. TO REFER "2SU2323 SERIES SPEC".
5. TO CONFORM TO THE SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
6. HALOGEN FREE PRODUCT IDENTIFICATION MARK ON JACK: ○
7. HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:
8. FOR REFLOW SOLDERING LEAD-FREE PROCESS.
9. PACKAGING:TAPE&REEL.



RECOMMENDED P.C.B. LAYOUT T=1.00  
TOP VIEW (TOLERANCE: ±0.05)



REV.	ECN NO. OR DESCRIPTION	REVISED	DATE
B	EONC110067 1.MODIFY SHIELD PIN DIM	BILLY	2011.05.30
C	EONC1101391 修改过孔尺寸与实物相符	BILLY	2011.06.24
D	ECN NO.: C120268 DELETE DIMENSION	ZJS	2012.8.17

NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
A	BODY	1	HIGH TEMP-THERMOPLASTIC UL 94V-0	BLACK
B	SHUNT-A	1	COPPER ALLOY 0.25T	GOLD FLASH
H	RING-B	1	COPPER ALLOY 0.25T	△ Gold Flash on contact area and solder tail, all over nickel plated
G	SHIELD	1	SPCC	Ni PLATING
F	TRANSFER TERMINAL	1	COPPER ALLOY 0.20T	△
E	BREAK TERMINAL	1	COPPER ALLOY 0.20T	Gold Flash on contact area
D	RING-A	1	COPPER ALLOY 0.20T	and solder tail, all over nickel plated
C	HP	1	COPPER ALLOY 0.25T	
B	EARTH	1	COPPER ALLOY 0.20T	

DECIMALS:	ANGLES:
X : ±0.5	X : ±2°
X.X : ±0.3	X.X : ±1°
X.XX : ±0.2	

TITLE	PART NO.	SCALE	UNIT	REV.
3.5Ø PHONE JACK	2SJ2323-001111	1:1	mm	D
CUSTOMER COPY				

Singatron Enterprise Co., Ltd.  
信登企業股份有限公司